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December 16, 2003

Commissioner F	or Patents
P.O. Box 1450	
Alexandria, VA	22313-1450

Re:

Applicant(s):

Small et al.

Title:

Compositions of Chemical Mechanical Planarization of Copper

Application No.:

10/017,934

Filing Date:

December 12, 2001

Examiner:

Umez Eronini, Lynette T.

Group Art Unit:

1765

Docket No.:

CHEM.001US0

Conf. No.:

1435

Dear Sir:

Transmitted herewith are the following documents in the above-identified application:

(1) Return Receipt Postcard;

(2) This Transmittal Letter (in duplicate); and

(3) Supplemental Amendment and Attachments (27 pages).

No additional fee is required.

The fee has been calculated as shown below:

CLAIMS AS AMENDED

	Claims Remaining <u>After Amendment</u>		Highest No. Previously Paid For		Present Extra		<u>Rate</u>		Additional <u>Fee</u>	
Total Clai	ms 23	Minus	23	=	0	x	\$18.00	\$		0.00
Independe Claims	ent 2	Minus	2	=	0	х	\$86.00	\$		0.00
Fee of for the first filing of one or more multiple \$ dependent claims per application \$										
	for Petition for Extension							\$		
_ _	Total additional fe	for this An	nendment:					\$		<u>0.00</u>
Conditional Petition for Extension of Time: If an extension of time is required for timely filing of the enclosed document(s) after all papers filed with this transmittal have been considered, an extension of time is hereby requested.										
	Please charge any additional fees required and credit any overpayment to our Deposit Account No. 502664.									
						7	Րotal։	\$		0.00

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Signature

Respectfully submitted,

K. Alison de Runtz

Reg. No. 37,119



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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DEC 31 2003 Compositions for Chemical Mechanical Planarization of Copper

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Commissioner for Patents, Washington, D.C. 20231, on __

Signature

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

SUPPLEMENTAL AMENDMENT

Sir:

Entry of this supplemental amendment, prior to further reconsideration of the abovereferenced application, is respectfully requested.